

DHG10I600PA

preliminary

 $V_{RRM} = 600 V$

 $I_{FAV} = 10 A$

 t_{rr} = 35 ns

High Performance Fast Recovery Diode Low Loss and Soft Recovery Single Diode

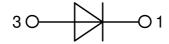
Sonic Fast Recovery Diode

Part number

DHG10I600PA



Backside: cathode



Features / Advantages:

- Planar passivated chips
- Very low leakage currentVery short recovery time
- Improved thermal behaviour
- Very low Irm-values
- Very soft recovery behaviour
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low Irm reduces:
- Power dissipation within the diode
- Turn-on loss in the commutating switch

Applications:

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode
- Rectifiers in switch mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)

Package: TO-220

- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

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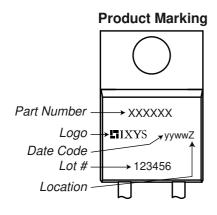
Fast Diode			Ratings				
Symbol	Definition	Conditions		min.	typ.	max.	Unit
V _{RSM}	max. non-repetitive reverse blockii	ng voltage	$T_{VJ} = 25^{\circ}C$			600	V
V _{RRM}	max. repetitive reverse blocking vo	oltage	$T_{VJ} = 25^{\circ}C$			600	V
IR	reverse current, drain current	$V_R = 600 \text{ V}$	$T_{VJ} = 25^{\circ}C$			30	μΑ
		$V_R = 600 \text{ V}$	$T_{VJ} = 125^{\circ}C$			1.2	mΑ
V _F	forward voltage drop	I _F = 10 A	$T_{VJ} = 25^{\circ}C$			2.23	V
		$I_F = 20 \text{ A}$				3.13	٧
		I _F = 10 A	T _{VJ} = 125°C			2.18	V
		$I_F = 20 \text{ A}$				3.29	V
I FAV	average forward current	T _C = 95°C	T _{vJ} = 150°C			10	Α
		rectangular d = 0.5					
V _{F0}	threshold voltage		T _{VJ} = 150°C			1.04	٧
\mathbf{r}_{F}	slope resistance	ss calculation only				104	mΩ
R _{thJC}	thermal resistance junction to case	;				1.8	K/W
R _{thCH}	thermal resistance case to heatsin	k			0.5		K/W
P _{tot}	total power dissipation		$T_C = 25^{\circ}C$			70	W
I _{FSM}	max. forward surge current	$t = 10 \text{ ms}$; (50 Hz), sine; $V_R = 0 \text{ V}$	$T_{VJ} = 45^{\circ}C$			80	Α
CJ	junction capacitance	$V_R = 400 \text{V}$ f = 1 MHz	$T_{VJ} = 25^{\circ}C$		6		pF
I _{RM}	max. reverse recovery current		$T_{VJ} = 25 ^{\circ}\text{C}$		4		Α
		$I_F = 10 \text{ A}; V_R = 400 \text{ V}$	$T_{VJ} = {}^{\circ}C$		tbd		Α
t _{rr}	reverse recovery time	$\begin{cases} I_F = 10 \text{ A}; V_R = 400 \text{ V} \\ -di_F /dt = 200 \text{ A}/\mu\text{s} \end{cases}$	$T_{VJ} = 25 ^{\circ}C$		35		ns
	J	1	$T_{VJ} = {}^{\circ}C$		tbd		ns



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Package TO-220			Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit
I _{RMS}	RMS current	per terminal			35	Α
T _{VJ}	virtual junction temperature		-55		150	°C
T _{op}	operation temperature		-55		125	°C
T _{stg}	storage temperature		-55		150	°C
Weight				2		g
M _D	mounting torque		0.4		0.6	Nm
F_c	mounting force with clip		20		60	N



Part description

D = Diode

H = Sonic Fast Recovery Diode

G = extreme fast

10 = Current Rating [A]

I = Single Diode

600 = Reverse Voltage [V] PA = TO-220AC (2)

17 - 10-22070 (2

Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	DHG10I600PA	DHG10I600PA	Tube	50	503581

Similar Part	Package	Voltage class
DHG10I600PM	TO-220ACFP (2)	600

Equivalent Circuits for Simulation			* on die level	$T_{VJ} = 150$ °C
$I \rightarrow V_0$)—[R ₀]-	Fast Diode		
V _{0 max}	threshold voltage	1.04		V
R_{0max}	slope resistance *	101		$m\Omega$